



**Alfa-MOS
Technology**

**AFN1602E
20V N-Channel
Enhancement Mode MOSFET**

General Description

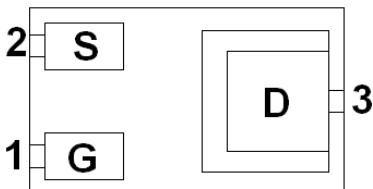
AFN1602E, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge.

These devices are particularly suited for low voltage power management, such as smart phone and notebook computer, and low in-line power loss are needed in commercial industrial surface mount applications.

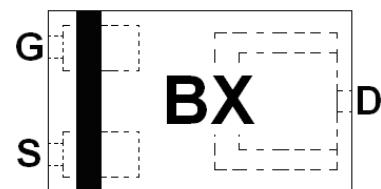
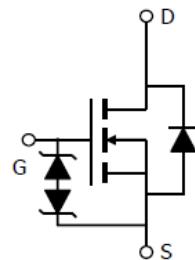
Features

- $I_D=0.8A, R_{DS(ON)}=360m\Omega @ V_{GS}=4.5V$
- $I_D=0.7A, R_{DS(ON)}=420m\Omega @ V_{GS}=2.5V$
- $I_D=0.5A, R_{DS(ON)}=560m\Omega @ V_{GS}=1.8V$
- Low Offset (Error) Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Battery Voltage Operation
- ESD Protected
- DFN1.0X0.6-3L package design

Pin Description (DFN1.0X0.6-3L)



BOTTOM VIEW



TOP VIEW

Application

- Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Smart Phones, Pagers

Pin Define

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN1602EFN106RG	BX	DFN1.0X0.6-3L	Tape & Reel	10000 EA

※ B Product Code

※ X Monthly Code

(even year : A, B~L)

(odd year : M, N~X)

※ AFN1602EFN106RG : 7" Tape & Reel ; Pb-Free ; Halogen-Free



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Absolute Maximum Ratings

($T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	20	V
Gate –Source Voltage	V_{GSS}	± 12	V
Continuous Drain Current($T_J=150^\circ\text{C}$)	I_D	0.7	A
		0.4	
Pulsed Drain Current	I_{DM}	1.0	A
Continuous Source Current(Diode Conduction)	I_S	0.3	A
Power Dissipation	P_D	0.27	W
		0.16	
Operating Junction Temperature	T_J	-55/150	°C
Storage Temperature Range	T_{STG}	-55/150	°C

Electrical Characteristics

($T_A=25^\circ\text{C}$ Unless otherwise noted)

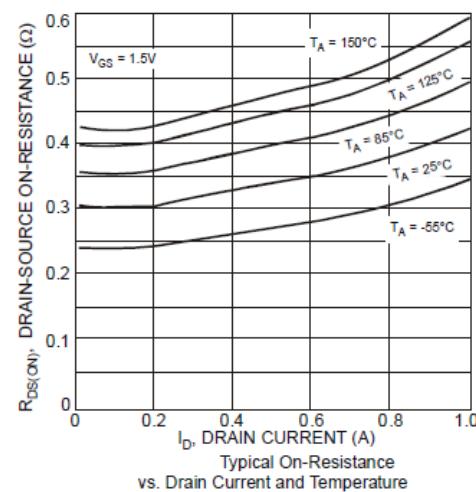
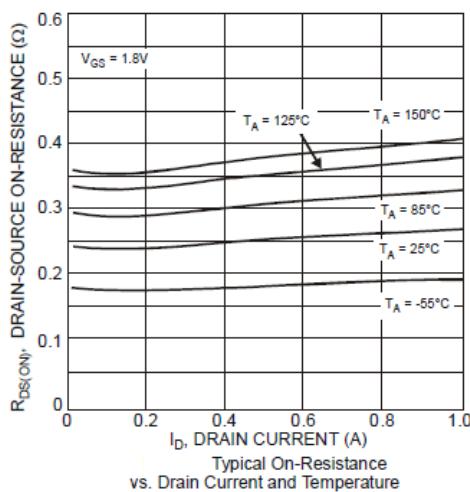
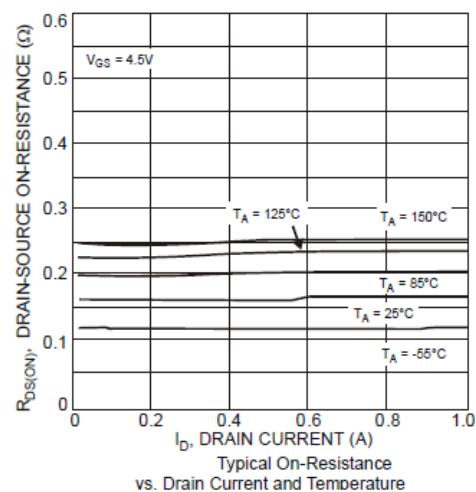
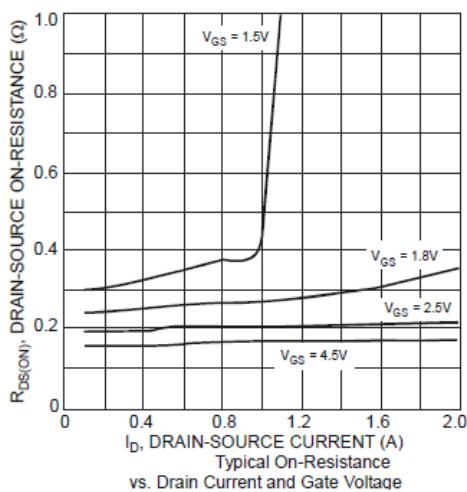
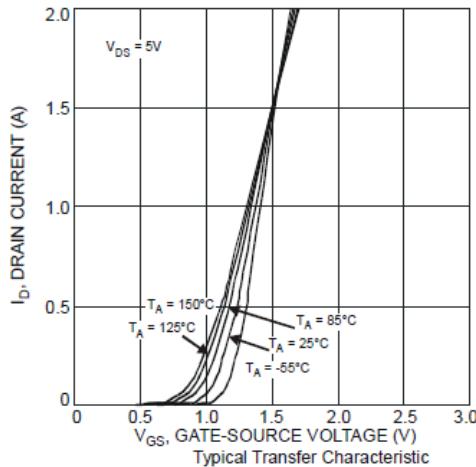
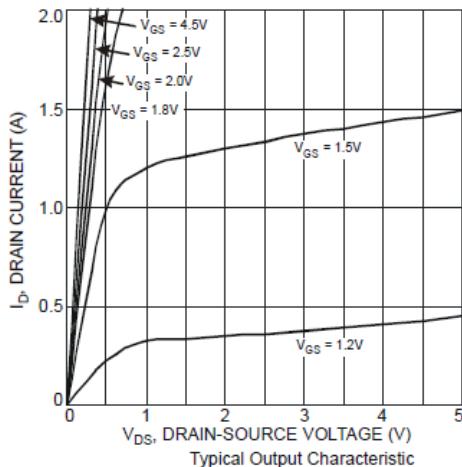
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	20			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	0.3		1.0	
Gate Leakage Current	I_{GSS}	$V_{DS}=0\text{V}, V_{GS}=\pm 12\text{V}$			± 1	mA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=20\text{V}, V_{GS}=0\text{V}$			1	uA
		$V_{DS}=20\text{V}, V_{GS}=0\text{V}$ $T_J=85^\circ\text{C}$			5	
On-State Drain Current	$I_{D(\text{on})}$	$V_{DS}\geq 5\text{V}, V_{GS}=4.5\text{V}$	0.7			A
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS}=4.5\text{V}, I_D=0.8\text{A}$		240	360	mΩ
		$V_{GS}=2.5\text{V}, I_D=0.7\text{A}$		300	420	
		$V_{GS}=1.8\text{V}, I_D=0.5\text{A}$		420	560	
Forward Transconductance	g_{FS}	$V_{DS}=10\text{V}, I_D=0.4\text{A}$		1		S
Diode Forward Voltage	V_{SD}	$I_S=0.15\text{A}, V_{GS}=0\text{V}$		0.65	1.2	V
Dynamic						
Input Capacitance	C_{iss}	$V_{DS}=10\text{V}, V_{GS}=0\text{V}$ $f=1\text{MHz}$		70		pF
Output Capacitance	C_{oss}			8		
Reverse Transfer Capacitance	C_{rss}			6		
Total Gate Charge	Q_g	$V_{DS}=10\text{V}, V_{GS}=4.5\text{V}$ $I_D=0.6\text{A}$		1.06	1.38	nC
Gate-Source Charge	Q_{gs}			0.18		
Gate-Drain Charge	Q_{gd}			0.32		
Turn-On Time	$t_{d(on)}$	$V_{DD}=10\text{V}, R_L=20\Omega$ $I_D=0.8\text{A}, V_{GEN}=10\text{V}$		5	10	ns
	t_r			5	10	
Turn-Off Time	$t_{d(off)}$			35	70	
	t_f			15	30	



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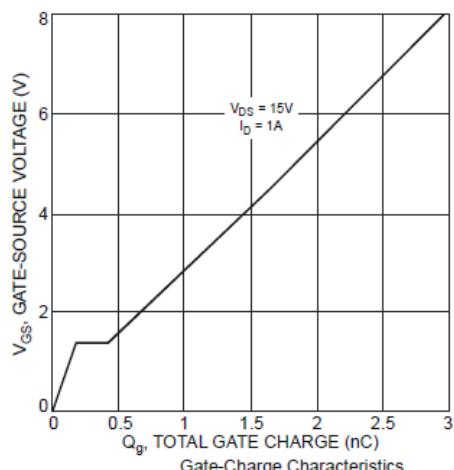
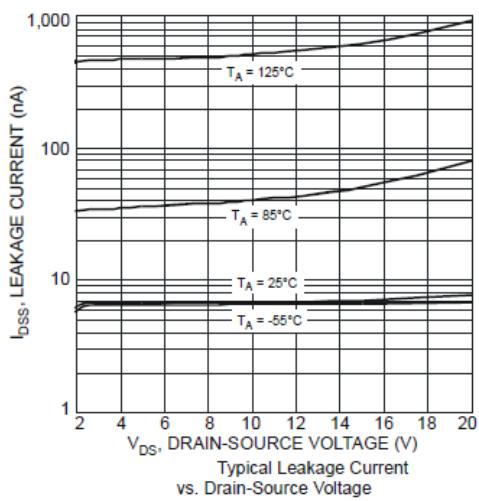
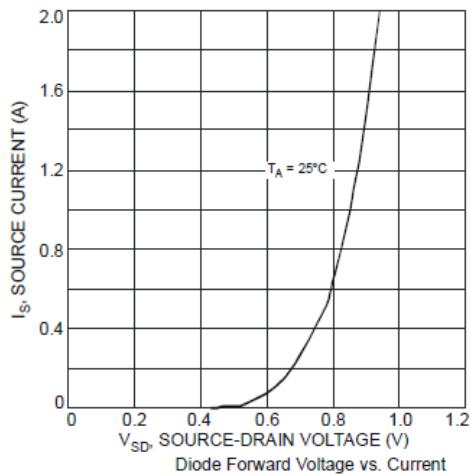
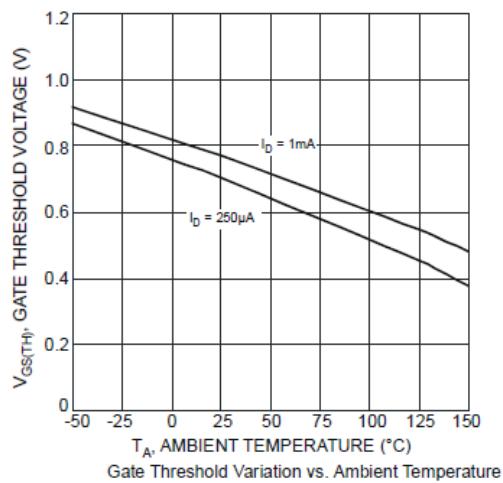
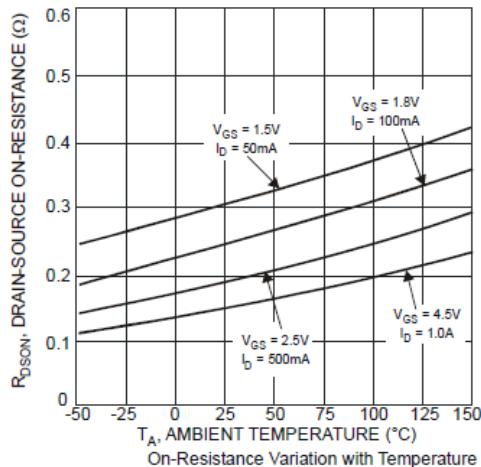
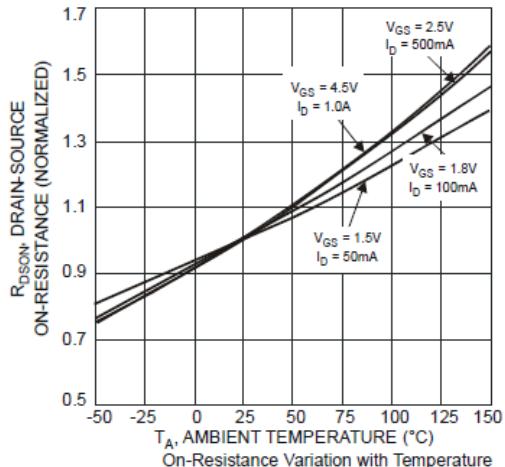
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Typical Characteristics





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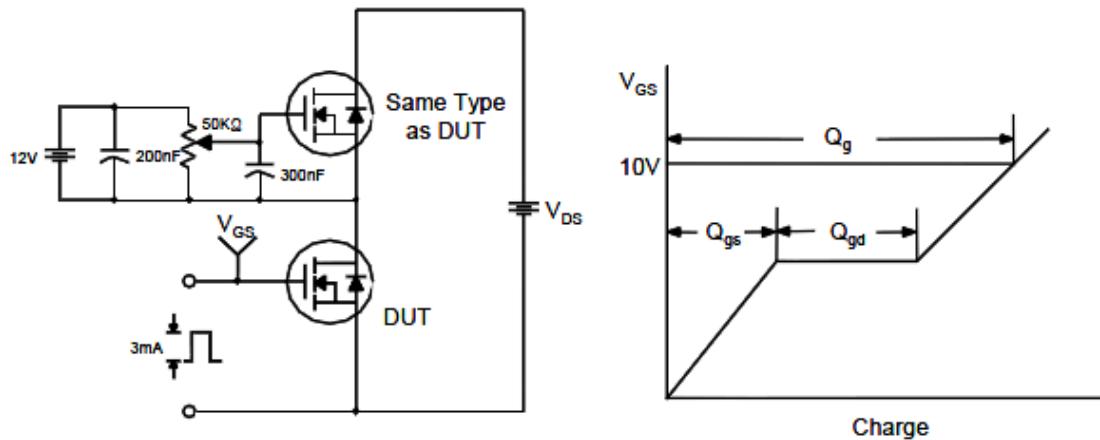


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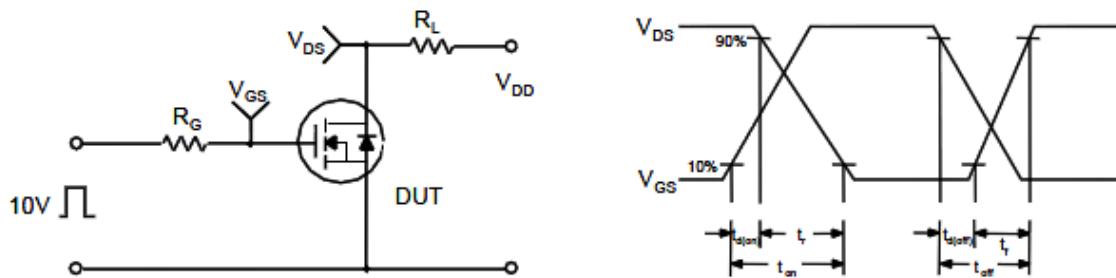
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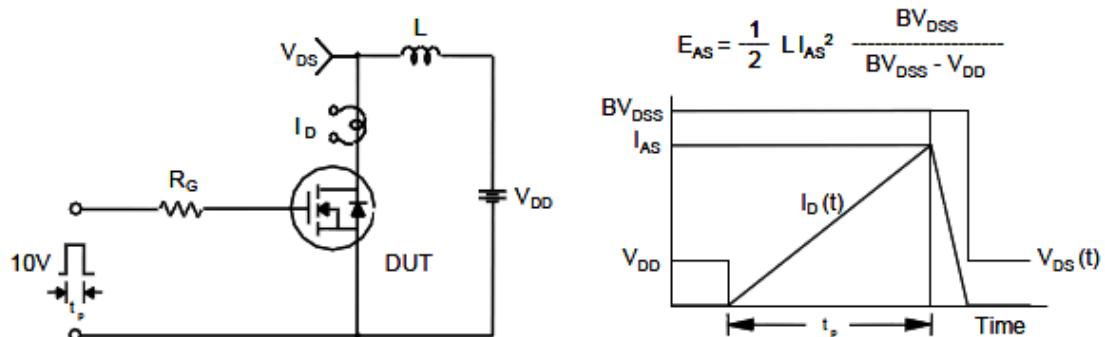
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

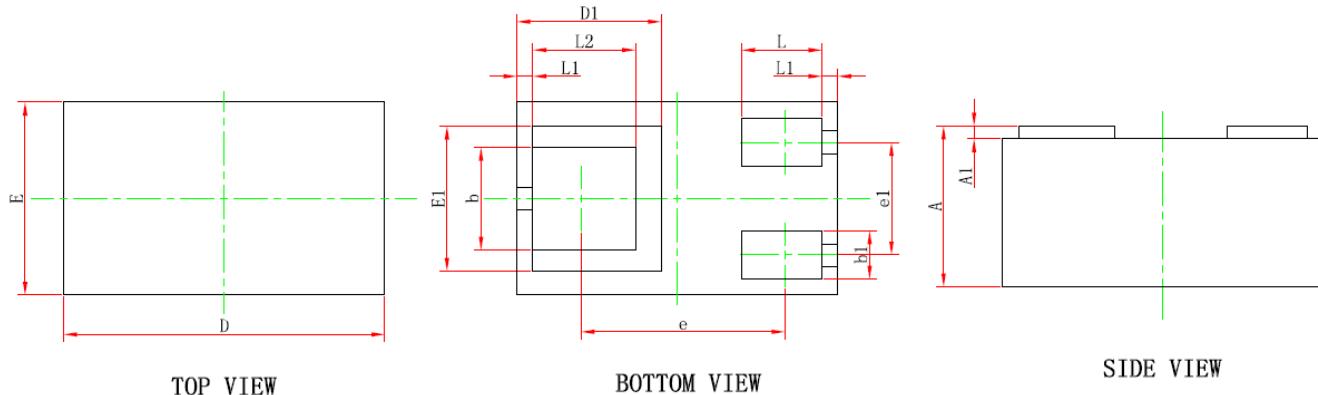




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Package Information (DFN1.0X0.6-3L)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.450	0.550	0.018	0.022
A1	0.010	0.100	0.000	0.004
D	0.950	1.050	0.037	0.041
E	0.550	0.650	0.022	0.026
D1	0.450REF.		0.018REF.	
E1	0.450REF.		0.018REF.	
b	0.270	0.370	0.011	0.015
b1	0.100	0.200	0.004	0.008
e	0.635REF.		0.025REF.	
e1	0.300	0.400	0.012	0.016
L	0.200	0.300	0.008	0.012
L1	0.050REF.		0.002REF.	
L2	0.270	0.370	0.011	0.015

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